

Quarterly Reliability Monitoring Results

Quarters: Q1/2022 to Q4/2023

Based on structural similarity

Supplier Nexperia B.V. Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test		User Part Number						
		BAV70QB-Q						
		Part Description						
		Nexperia DHAM	Bipolar Diode					
		MCD package						
		Test Conditions	Duration	# Lots	# Quantity	# Rejects		
	TEST							
	Pre- and Post-Stress							
# E1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below		
		JESD22-A113						
		Bake Tamb = 125 °C	24 hours					
	PC	Soak Tamb = 85 °C, RH = 85%	168 hours					
# A1	Preconditioning	Reflow soldering	3 cycles	212	9600	0		
		MIL-STD-750-1						
	HTRB	M1038 Method A						
	High Temperature Reverse	Tj = Tjmax, Vr = 100% of max. datasheet						
# B1	Bias	reverse voltage	1000 hours	110	4920	0		
	TC	JESD22-A104						
# A4	Temperature Cycling	-65 °C to Tjmax, not to exceed 150°C	1000 cycles	53	2400	0		
		150000 4440						
# A3 or	UHAST Unbiased HAST	JESD22-A118 Tamb = 130 °C, RH = 85 %						
AS OI	Olibiased HAST	· · · · · · · · · · · · · · · · · · ·	- 96 hours	53	2400	0		
" 42 li		JESD22-A102						
	AC Autoclave	Tamb = 121 °C, RH = 100 % Pressure = 205 kPa (29.7 psia)						
# A3 alt	Autociave	Pressure = 205 kPa (29.7 psia)						
	H3TRB	JESD22-A101						
	High Humidity High	Tamb = 85 °C, RH = 85%, VR = 80 % of						
# A2 alt		rated reverse voltage ^[1]	1000 hours	53	2400	0		
# AZ dit	. cperature Reverse Blas	MIL-STD-750 Method 1037	1000 110015	J.J.	2 7 00	U		
	IOL	ton = toff, devices powered to insure ΔT_i =						
# A5	Intermittent Operating Life		1000 hours	53	2400	0		
- 73	Intermittent Operating Life	100 0 101 15000 070105	1000 110013	33	2700	U		
	RSH	JESD22-A111						
# C8	Resistance to Solder Heat		10 s	n.a.	n.a.	n.a.		
	SD	200 0 - 0 0	10 3	ma.		11.0.		
# C10	Solderability	J-STD-002		37	1110	0		
C10	33.acrubinty	, o.b ooc		31	1110	•		

^[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1)
Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia					
DHAM	Small Signal Bipolar Diode	4920	0	0,86	1,16E+09

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